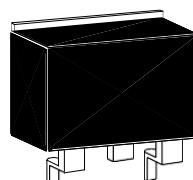


P-Channel Enhancement Mode Power MOSFET

Features:

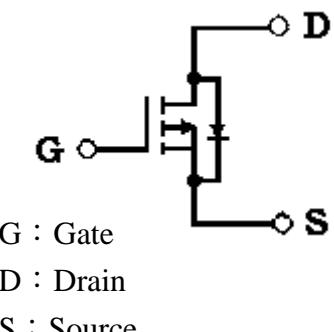
- Low Gate Charge
- Simple Drive Requirement
- Repetitive Avalanche Rated
- Fast Switching Characteristic
- RoHS compliant package

TO-263



G D S

BV _{DSS}	-80V
I _D @ V _{GS} =-10V, T _c =25°C	-63A
I _D @ V _{GS} =-10V, T _A =25°C	-8A
R _{DSON(TYP)} @ V _{GS} =-10V, I _D =-50A	13.5mΩ



G : Gate

D : Drain

S : Source

Ordering Information

Device	Package	Shipping
KWE012P08	TO-263 (Pb-free lead plating and RoHS compliant package)	800 pcs / Tape & Reel

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V_{DS}	-80	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current @ $T_C=25^\circ\text{C}$, $V_{GS}=-10\text{V}$ (Note 5)	I_D	-63	A
Continuous Drain Current @ $T_C=100^\circ\text{C}$, $V_{GS}=-10\text{V}$ (Note 5)		-39.8	
Pulsed Drain Current (Note 3)	I_{DM}	-214	A
Continuous Drain Current @ $T_A=25^\circ\text{C}$, $V_{GS}=-10\text{V}$ (Note 2)	I_{DSM}	-8	
Continuous Drain Current @ $T_A=70^\circ\text{C}$, $V_{GS}=-10\text{V}$ (Note 2)		-6.4	
Avalanche Current @ $L=0.1\text{mH}$ (Note 3)	I_{AS}	-90	
Avalanche Energy @ $L=1\text{mH}$, $I_D=-40\text{A}$, $V_{DD}=-25\text{V}$ (Note 4)	E_{AS}	800	mJ
Repetitive Avalanche Energy	E_{AR}	12	
Power Dissipation	P_D	125	W
		50	
Power Dissipation	P_{DSM}	2	
		1.3	
Operating Junction and Storage Temperature	T_J, T_{stg}	-55~+150	$^\circ\text{C}$

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case, max	$R_{\theta JC}$	1	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-ambient, max, $t \leq 10\text{s}$ (Note 2)	$R_{\theta JA}$	15	
Thermal Resistance, Junction-to-ambient, max (Note 2)		62	

- Note : 1.The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2 oz. copper, in a still air environment with $T_A=25^\circ\text{C}$. The power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.
3. Pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$. Ratings are based on low frequency and low duty cycles to keep initial $T_J=25^\circ\text{C}$.
4. 100% tested by conditions of $L=0.1\text{mH}$, $I_{AS}=-30\text{A}$, $V_{GS}=-10\text{V}$, $V_{DD}=-25\text{V}$.
5. Calculated continuous drain current based on maximum allowable junction temperature.
6. The static characteristics are obtained using <300μs pulses, duty cycle 0.5% maximum.
7. The $R_{\theta JA}$ is the sum of thermal resistance from junction to case $R_{\theta JC}$ and case to ambient.

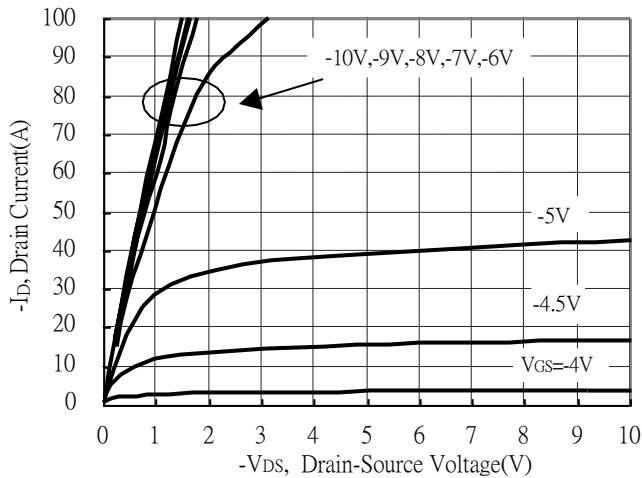
Characteristics (Tc=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	-80	-	-	V	V _{GS} =0V, I _D =-250μA
V _{GS(th)}	-2	-	-4		V _{DS} = V _{GS} , I _D =-250μA
G _{FS}	-	32.5	-	S	V _{DS} =-10V, I _D =-20A
I _{GSS}	-	-	±100	nA	V _{GS} =±20V, V _{DS} =0V
I _{DSS}	-	-	-1	μA	V _{DS} =-64V, V _{GS} =0V
	-	-	-10		V _{DS} =-64V, V _{GS} =0V, T _j =125°C
*R _{DSON}	-	13.5	18.5	mΩ	V _{GS} =-10V, I _D =-50A
Dynamic					
*Q _g	-	91.8	-	nC	I _D =-50A, V _{DS} =-40V, V _{GS} =-10V
*Q _{gs}	-	18.4	-		
*Q _{gd}	-	32.7	-	ns	V _{DS} =-40V, I _D =-50A, V _{GS} =-10V, R _G =1Ω
*t _{d(ON)}	-	35	-		
*t _r	-	28.8	-		
*t _{d(OFF)}	-	74.6	-		
*t _f	-	20.8	-	pF	V _{GS} =0V, V _{DS} =-40V, f=1MHz
C _{iss}	-	5013	-		
C _{oss}	-	386	-		
C _{rss}	-	125	-	Ω	f=1MHz
R _g	-	2.4	-		
Source-Drain Diode					
*I _s	-	-	-63	A	Is=-30A, V _{GS} =0V
*I _{SM}	-	-	-214		
*V _{SD}	-	-0.88	-1.2	V	Is=-30A, V _{GS} =0V
*t _{rr}	-	30	-	ns	I _F =-30A, V _{GS} =0V, dI _F /dt=100A/μs
*Q _{rr}	-	37.7	-		

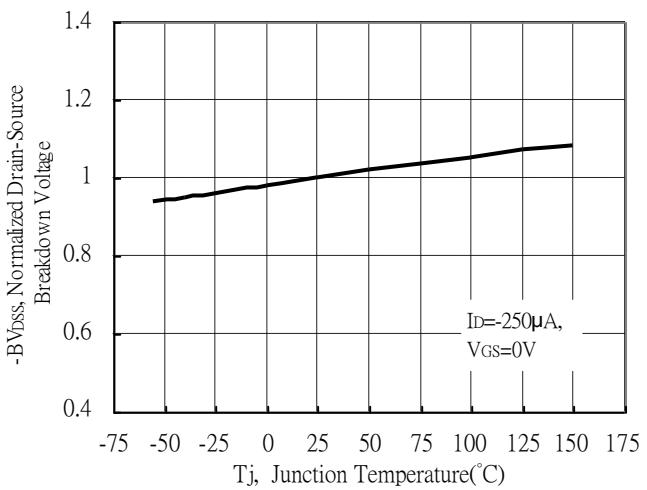
*Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

Typical Characteristics

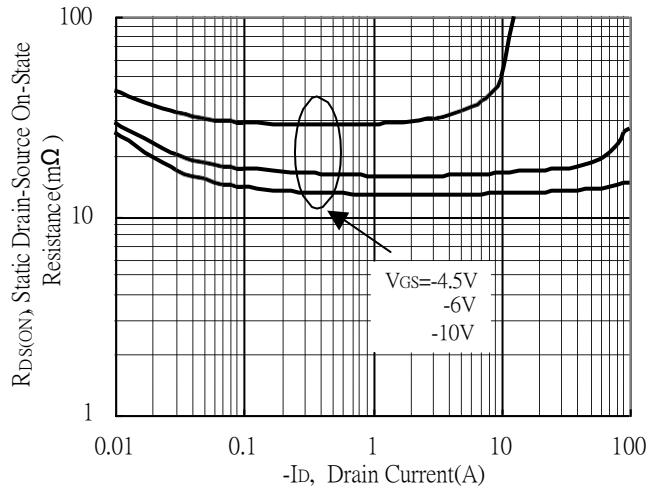
Typical Output Characteristics



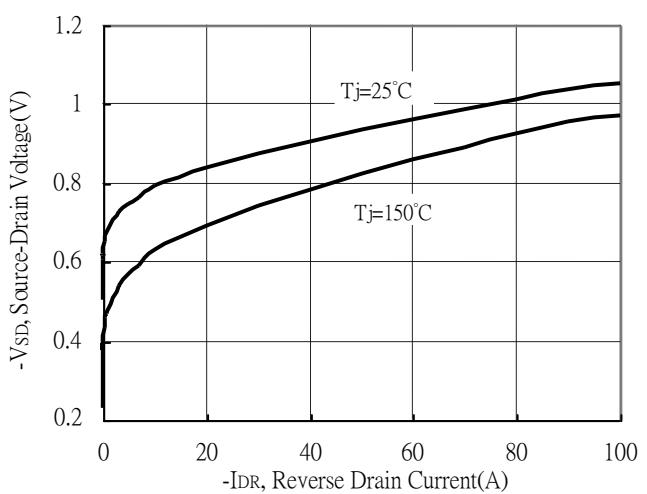
Breakdown Voltage vs Junction Temperature



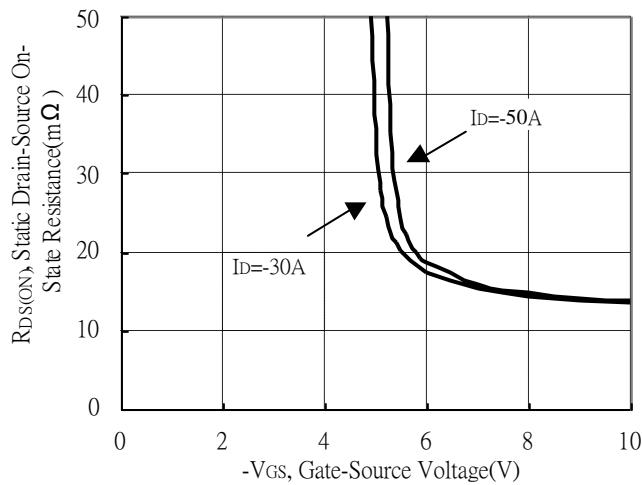
Static Drain-Source On-State resistance vs Drain Current



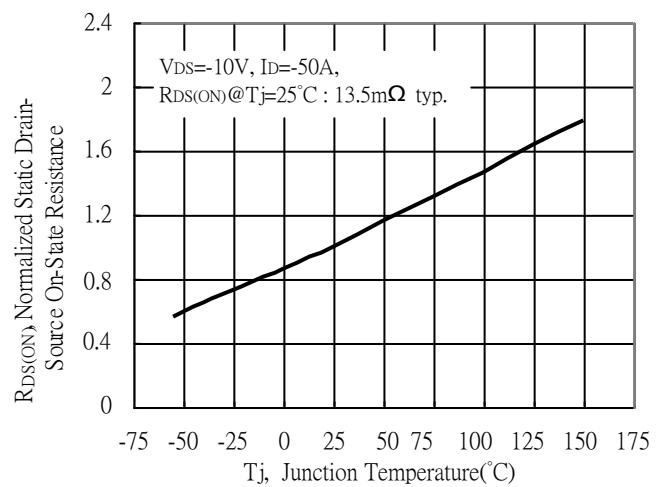
Reverse Drain Current vs Source-Drain Voltage



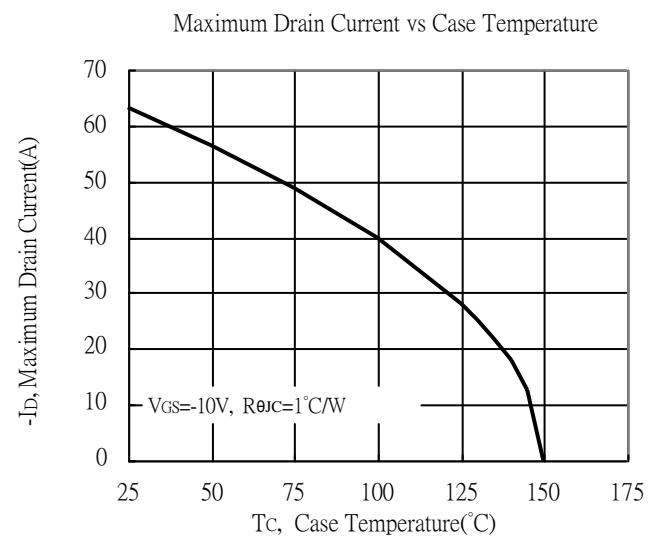
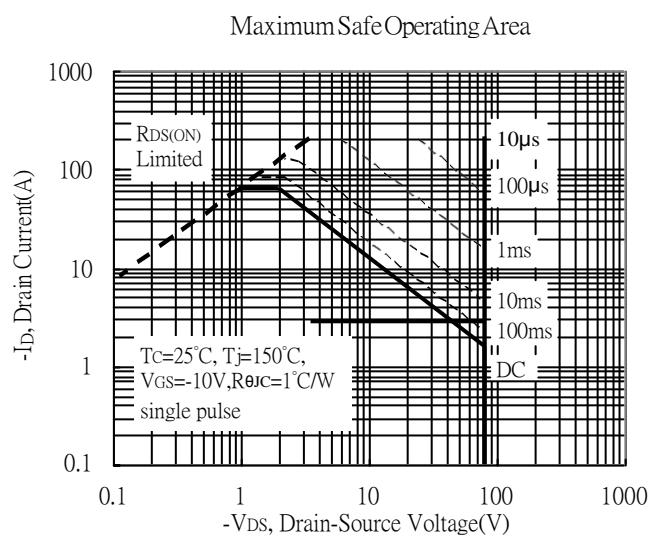
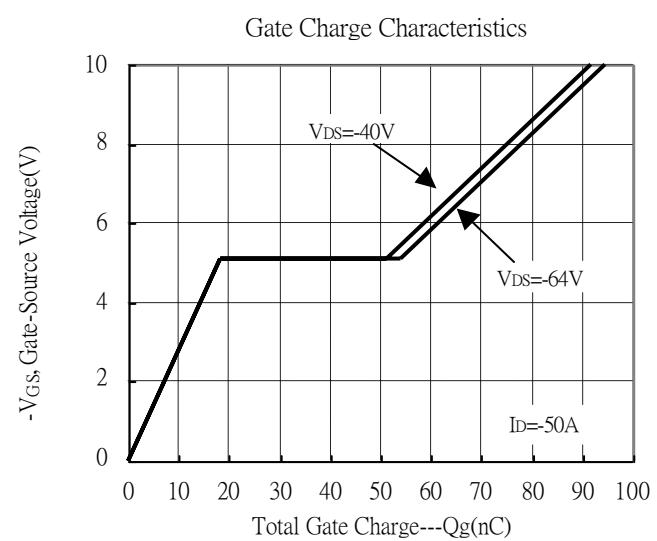
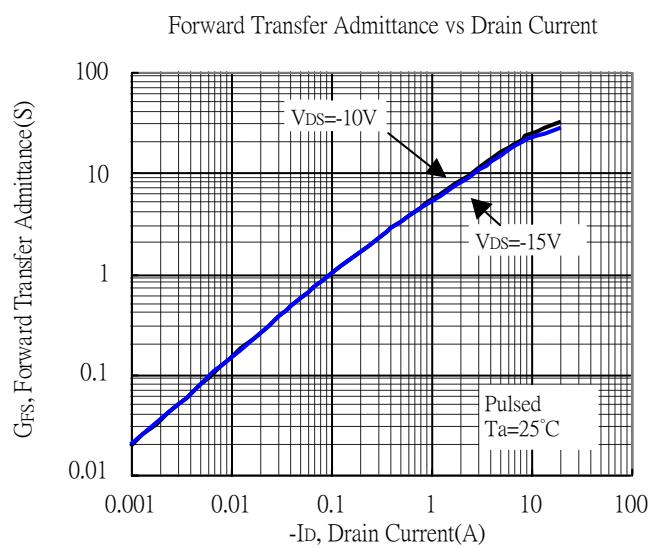
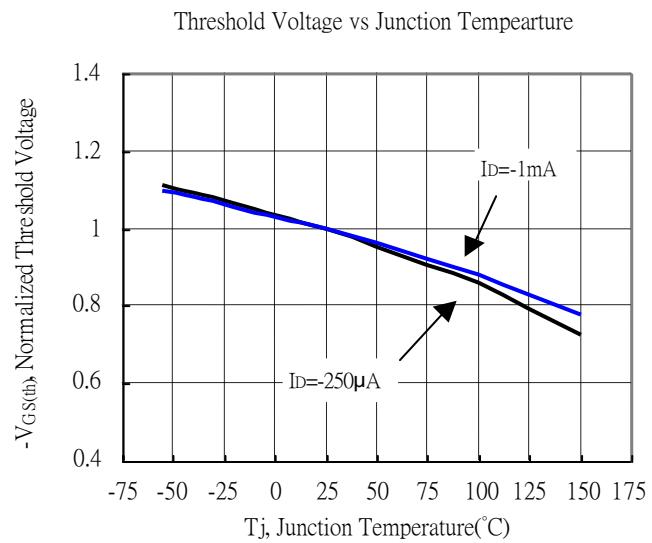
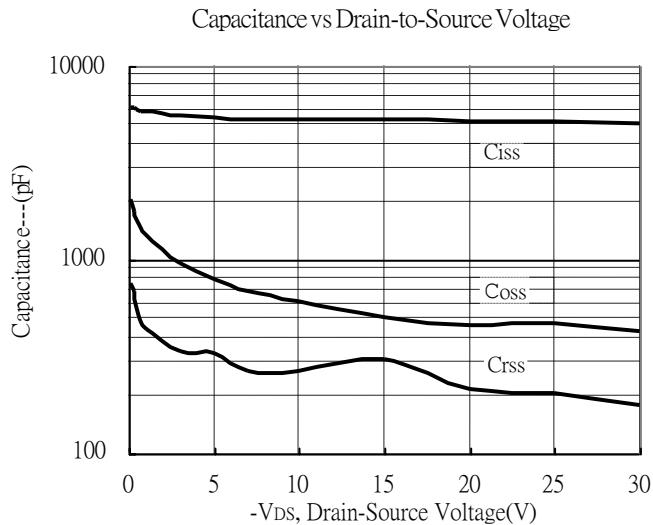
Static Drain-Source On-State Resistance vs Gate-Source Voltage



Drain-Source On-State Resistance vs Junction Temperature

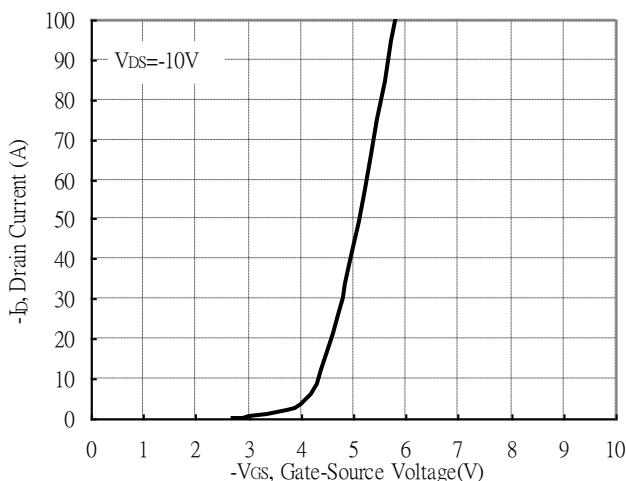


Typical Characteristics(Cont.)

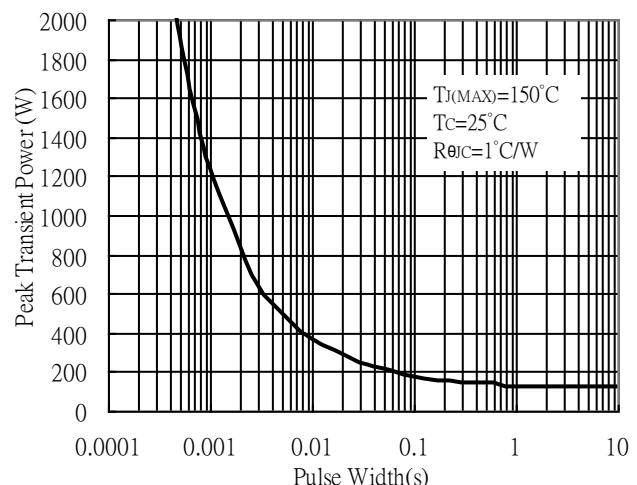


Typical Characteristics(Cont.)

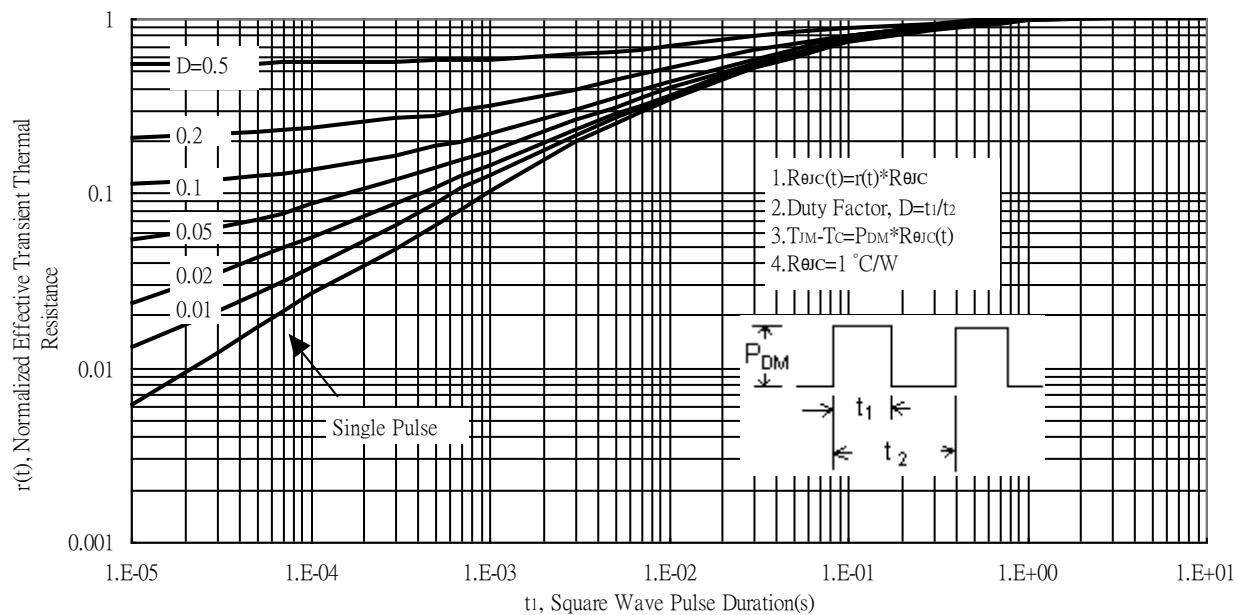
Typical Transfer Characteristics



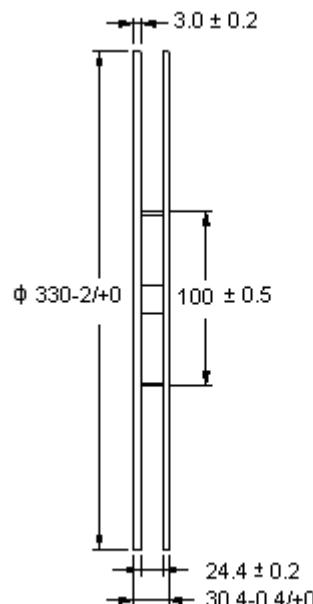
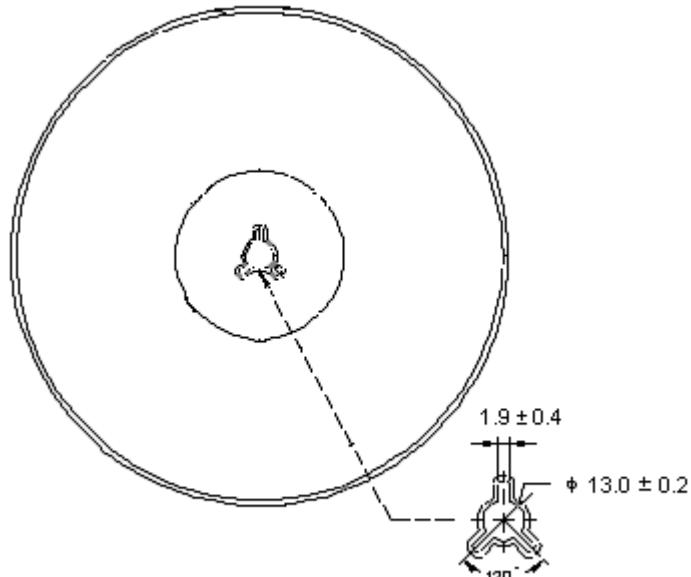
Single Pulse Maximum Power Dissipation



Transient Thermal Response Curves

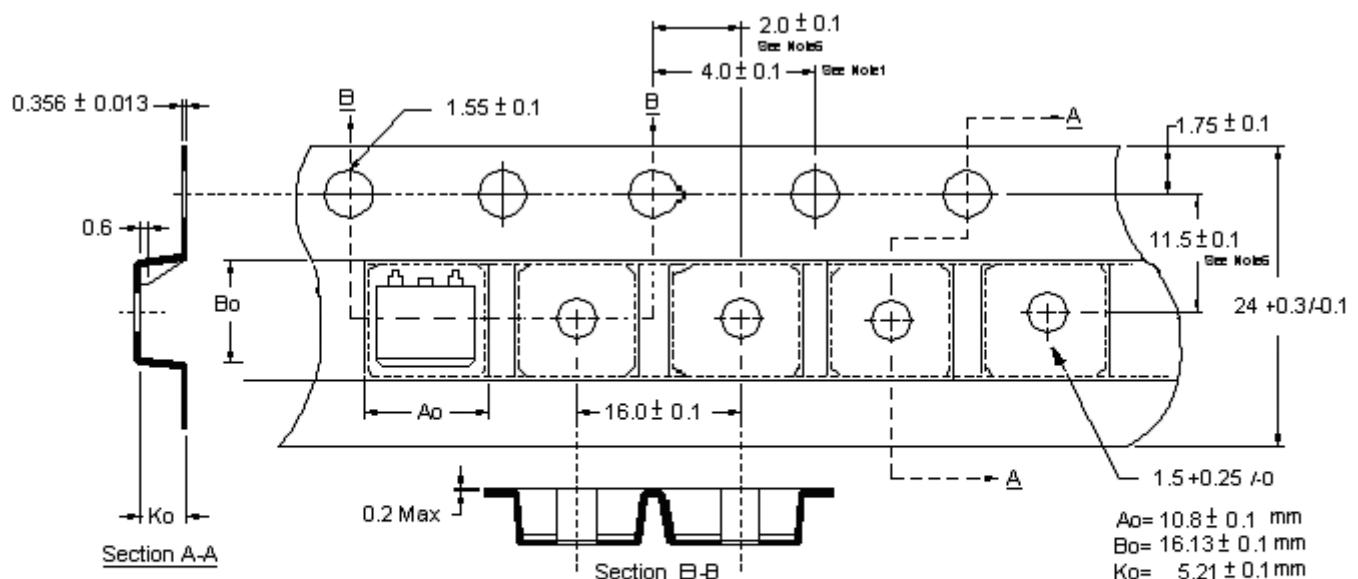


Reel Dimension



Unit: millimeter

Carrier Tape Dimension

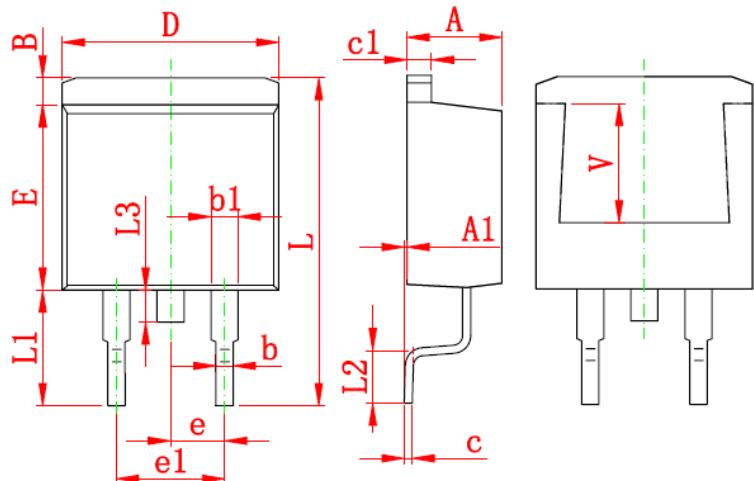


Notes:

1. 10 sprocket hole pitch cumulative tolerance ± 0.2 .
2. Camber not to exceed 1mm in 100mm.
3. Material: Conductive Black Advantek Polystyrene.
4. A_o & B_o measured on a plane 0.3mm above the bottom of the pocket.
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

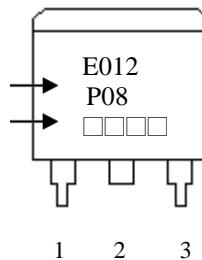
Unit : millimeter

TO-263 Dimension



Marking :

Device Name
Date Code



Style : Pin 1.Gate 2.Drain 3.Source
3-Lead Plastic Surface Mounted Package

Date Code : (From left to right)

First Code : Year code, the last digit of Christian year. For example, 2014→4, 2015→5, 2016→6, ..., etc.

Second Code : Month code, Jan→A, Feb→B, Mar→C, Apr→D, May→E, Jun→F, Jul→G, Aug→H, Sep→J,

Oct→K, Nov→L, Dec→M

Third and fourth codes : production serial number, 01~99

*:Typical

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184	E	8.500	8.900	0.335	0.350
A1	0.000	0.150	0.000	0.006	e	*2.540		*0.100	
B	1.170	1.370	0.046	0.054	e1	4.980	5.180	0.196	0.204
b	0.710	0.910	0.028	0.036	L	15.050	15.450	0.593	0.608
b1	1.170	1.370	0.046	0.054	L1	5.080	5.480	0.200	0.216
c	0.310	0.530	0.012	0.021	L2	2.340	2.740	0.092	0.108
c1	1.170	1.370	0.046	0.054	L3	1.300	1.700	0.051	0.067
D	10.010	10.310	0.394	0.406	V	5.600	REF	0.220	REF